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#### SEMICONDUCTOR MANUFACTURING INTERNATIONAL CORPORATION

# (Incorporated in the Cayman Islands with limited liability) (STOCK CODE: 0981)

#### SMIC REPORTS RESULTS FOR THE THREE MONTHS ENDED MARCH 31, 2011

- Revenue down by 9.3% to \$370.6million in 1Q11 from \$408.6 million in 4Q10 and up by 7.2% compared to 1Q10.
- Gross margin was 18.6% in 1Q11 compared to 24.3% in 4Q10 primarily due to a decline in fab utilization.
- Net cash flow from operations decreased to \$73.4million in 1Q11 from \$248.6million in 4Q10.
- Income attributable to holders of ordinary shares was US\$10.2 million in 1Q11, compared to income of US\$68.6million in 4Q10.
- Diluted EPS was \$0.02 per ADS.

Set out below is a copy of the full text of the press release by the Company on May 19, 2011, in relation to its results for the three months ended March 31, 2011.

All currency figures stated in this report are in US Dollars unless stated otherwise.

The financial statement amounts in this report are determined in accordance with US GAAP.

Shanghai, China – May 19, 2011. Semiconductor Manufacturing International Corporation (NYSE: SMI; SEHK: 981) ("SMIC" or the "Company"), one of the leading semiconductor foundries in the world, today announced its consolidated results of operations for the three months ended March 31, 2011.

#### First Quarter 2011 Highlights:

- Revenue down by 9.3% to \$370.6million in 1Q11 from \$408.6million in 4Q10 and up by 7.2% compared to 1Q10.
- Gross margin was 18.6% in 1Q11 compared to 24.3% in 4Q10 primarily due to a decline in fab utilization.
- Net cash flow from operations decreased to \$73.4million in 1Q11 from \$248.6million in 4Q10.
- Income attributable to holders of ordinary shares was US\$10.2million in 1Q11, compared to income of

US\$68.6million in 4Q10.

• Diluted EPS was \$0.02 per ADS.

#### **Second Quarter 2011 Guidance:**

The following statements are forward looking statements which are based on current expectation and which involve risks and uncertainties, some of which are set forth under "Safe Harbor Statements" below.

- Revenue is expected to decline between 3% to 7%.
- Gross margin is expected to range from 15% to 18%.
- Operating expenses excluding foreign exchange differences are expected to range from \$82 million to \$86million.

Dr. David NK Wang, President and Chief Executive Officer of SMIC commented, "Highlighting our first-quarter performance, revenue increased 7% year-over-year and decreased 9% quarter-over-quarter to US\$371 million. The quarter-over-quarter revenue decline was largely due to first quarter seasonality and our key customers' transition to our 65nm and 45nm. Despite these situations, China displays resilience and in the first quarter, China sales grew 54% year-over-year and 3% quarter over quarter and now accounts for 36% of our revenue.

"We are happy to have announced an agreement with China Investment Corporation (or "CIC"), a sovereign wealth fund investment institution, to invest in SMIC for convertible preferred shares and warrants. These capital injections will further help SMIC to expand its technology roadmap and strengthen our foothold as one the leading foundries globally."

Dr. Wang further remarked, "On May 12th we announced the signing of a joint venture with Hubei Science & Technology Investment Corporation, to jointly invest in and manage the 12-inch wafer production line of Wuhan Xinxin. This joint cooperation will serve as a strategic component in our expansion plan over the next five years and will allow us to quickly expand and increase market share on advanced technology capacity."

Dr. Wang later added, "Despite the short-term setbacks, we look forward to regaining growth in the second half of 2011. The short-term customer transitions will continue to impact our business performance in second quarter 2011, but given our successful funding, capacity ramping, enhanced technology mix, operational improvements, and China positioning, we are on track in executing sustainable competitiveness for the long-term."

#### **Conference Call / Webcast Announcement**

Date: Friday, May 20, 2011

Time: 8:30 a.m. Shanghai time Dial-in numbers and pass code:

S 1-617-597-5342 (Pass code: SMIC) K 852-3002-1672 (Pass code: SMIC)

A live webcast of the 2010 fourth quarter announcement will be available at http://www.smics.com under the "Investor Relations" section, or at

URL: <a href="http://phx.corporate-ir.net/phoenix.zhtml?p=irol-eventDetails&c=176474&eventID=3981260">http://phx.corporate-ir.net/phoenix.zhtml?p=irol-eventDetails&c=176474&eventID=3981260</a>
An archived version of the webcast, along with an electronic copy of this news release will be available on the SMIC website for a period of 12 months following the webcast.

#### **About SMIC**

Semiconductor Manufacturing International Corporation ("SMIC"; NYSE: SMI; SEHK: 981) is one of the leading semiconductor foundries in the world and the largest and most advanced foundry in Mainland China, providing integrated circuit (IC) foundry and technology services at 0.35-micron to 45/40-nanometer. Headquartered in Shanghai, China, SMIC has a 300mm wafer fabrication facility (fab) and three 200mm wafer fabs in its Shanghai mega-fab, two 300mm wafer fabs in its Beijing mega-fab, a 200mm wafer fab in Tianjin, a 200mm fab under construction in Shenzhen, and an in-house assembly and testing facility in Chengdu. SMIC also has customer service and marketing offices in the U.S., Europe, and Japan, and a representative office in Hong Kong. In addition, SMIC manages and operates a 300mm wafer fab in Wuhan owned by Wuhan Xinxin Semiconductor Manufacturing Corporation.

For more information, please visit www.smics.com

### **Safe Harbor Statements**

(Under the Private Securities Litigation Reform Act of 1995)

This press release contains, in addition to historical information, "forward-looking statements" within the meaning of the "safe harbor" provisions of the U.S. Private Securities Litigation Reform Act of 1995. These forward-looking statements, including statements concerning our belief that we are on course to profitability, and statements under "Second Quarter 2011 Guidance" are based on SMIC's current assumptions, expectations and projections about future events. SMIC uses words like "believe," "anticipate," "intend," "estimate," "expect," "project" and similar expressions to identify forward-looking statements, although not all forward-looking statements contain these words. These forward-looking statements are necessarily estimates reflecting the best judgment of SMIC's senior

management and involve significant risks, both known and unknown, uncertainties and other factors that may cause SMIC's actual performance, financial condition or results of operations to be materially different from those suggested by the forward-looking statements including, among others, risks associated with cyclicality and market conditions in the semiconductor industry, the downturn in the global economy and the impact on China's economy, intense competition, timely wafer acceptance by SMIC's customers, timely introduction of new technologies, SMIC's ability to capture growth opportunities in China, supply and demand for semiconductor foundry services, industry overcapacity, shortages in equipment, components and raw materials, orders or judgments from pending litigation, availability of manufacturing capacity and financial stability in end markets.

Investors should consider the information contained in SMIC's filings with the U.S. Securities and Exchange Commission (SEC), including its annual report on 20-F filed with the SEC on June 29, 2010, especially in the "Risk Factors" and "Management's Discussion and Analysis of Financial Condition and Results of Operations" sections, and such other documents that SMIC may file with the SEC or The Hong Kong Stock Exchange Limited ("SEHK") from time to time, including on Form 6-K. Other unknown or unpredictable factors also could have material adverse effects on SMIC's future results, performance or achievements. In light of these risks, uncertainties, assumptions and factors, the forward-looking events discussed in this press release may not occur. You are cautioned not to place undue reliance on these forward-looking statements, which speak only as of the date stated, or if no date is stated, as of the date of this press release. Except as required by law, SMIC undertakes no obligation and does not intend to update any forward-looking statement, whether as a result of new information, future events or otherwise.

## **Summary of First Quarter 2011 Operating Results**

Amounts in US\$ thousands, except for EPS and operating data

	1Q11	4Q10	QoQ	1Q10	YoY
evenue	370,559	408,600	-9.3%	345,640	7.2%
ost of sales	301,782	309,325	-2.4%	291,322	3.6%
ross profit	68,777	99,275	-30.7%	54,317	26.6%
perating expenses	76,623	53,880	42.2%	78,715	-2.6%
come (loss)from operations	(7,846)	45,394	_	(24,397)	-67.8%
ther income (expenses), net	2,702	27,042	-90.0%	(157,097)	_
come tax (expenses)credit	128	(388)	_	2,374	-94.6%
et income (loss)after income taxes	(5,016)	72,048	_	(179,120)	-97.2%
ain (loss)from equity investment	1,016	304	234.2%	(455)	_
come (loss)on discontinued operations net of tax effect	14,742	(3,657)	_	(2,115)	_
et income (loss)	10,742	68,695	-84.4%	(181,690)	_
ccretion of interest to noncontrolling interest	(508)	(125)	306.4%	(259)	96.1%
come (loss)attributable to Semiconductor Manufacturing					
International Corporation	10,234	68,570	-85.1%	(181,949)	_
ross margin	18.6%	24.3%	)	15.7%	D
perating margin	-2.1%	11.1%	)	-7.1%	D
et income (loss)per ordinary share (basic)(1)	0.00	0.00		(0.01)	
et income (loss)per ADS (basic)	0.02	0.13		(0.41)	
et income (loss)per ordinary share (diluted) (1)	0.00	0.00		(0.01)	
et income (loss)per ADS (diluted)	0.02	0.13		(0.41)	
'afers shipped (in 8" wafers) <sup>(2)</sup>	471,231	517,404	-8.9%	455,010	3.6%
apacity utilization	72.2%	96.8%		92.1%	, )

#### Note:

- Revenue decreased to \$370.6million in 1Q11, down 9.3% QoQ from \$408.6million in 4Q10 due to a 8.9% decrease in wafer shipments.
- Cost of sales decreased to \$301.8million in 1Q11, down 2.4% QoQ from \$309.3million in 4Q10 primarily due to a decrease in wafer shipments.
- Gross profit of \$68.8million in 1Q11, compared to a gross profit of \$99.3million in 4Q10 and gross profit

<sup>(1)</sup> Based on weighted average ordinary shares of 27,371million (basic) and 27,371million (diluted) in 1Q11, 26,547million (basic) and 26,749million (diluted) in 4Q10 and 22,397 million (basic) and 22,397million (diluted) in 1Q10

<sup>(2)</sup> Including copper interconnects

- of \$54.3million in 1Q10.
- Gross margin was 18.6% in 1Q11 down from 24.3% in 4Q10 primarily due to a decline in fab utilization.
- R&D expenses increased to \$49.6million in 1Q11, up 5.4% QoQ from \$47.0million in 4Q10 due to an increase in personnel related expenses.
- G&A expenses were \$19.4million in 1Q11, compared to a gain of \$(7.5) million in 4Q10 due to a \$28.5million recovery from bad-debt write-off in 4Q10.
- Selling & marketing expenses decreased to \$7.7million in 1Q11, down 10.5% QoQ from \$8.6 million in 4Q10 primarily due to a decrease in selling activities.
- Income on discontinued operations of \$14.7million represents both the results of operations of Semiconductor Manufacturing International (AT)Corporation ("AT") for the period from January 1, 2011 to the date it was deconsolidated and a gain on deconsolidation of AT.

## **Analysis of Revenues**

Sales Analysis			
By Application	1Q11	4Q10	1Q10
omputer	3.3%	2.3%	4.3%
ommunications	44.5%	50.5%	51.5%
onsumer	42.5%	39.7%	37.0%
thers	9.7%	7.5%	7.2%
y Service Type	1Q11	4Q10	1Q10
ogic <sup>(1)</sup>	91.3%	93.1%	90.3%
emory	0.0%	0.0%	2.7%
ask Making, testing, others	8.7%	6.9%	7.0%
y Customer Type	1Q11	4Q10	1Q10
abless semiconductor companies	80.4%	79.6%	66.4%
tegrated device manufacturers (IDM)	13.5%	16.7%	17.0%
stem companies and others	6.1%	3.7%	16.6%
y Geography	1Q11	4Q10	1Q10
orth America	51.3%	56.4%	58.9%
hina <sup>(2)</sup>	35.6%	31.2%	24.4%
ırasia <sup>(3)</sup>	13.1%	12.4%	16.7%
'afer Revenue Analysis			

1Q11 4Q10 1Q10

y Technology (logic, memory & copper interconnect only)

065μm	13.3%	8.6%	1.7%
09μm	12.3%	15.4%	18.6%
13µm	24.1%	31.9%	35.5%
15μm	1.3%	1.2%	1.5%
18μm	31.6%	26.5%	24.2%
25μm	0.4%	0.5%	0.3%
35μm	17.0%	15.9%	18.2%

## Note:

- (1) Including 0.13 µm copper interconnects
- (2) Including Hong Kong
- (3) Excluding China

# Capacity\*

Fab / (Wafer Size)	1Q11	4Q10
nanghai Mega Fab (8")	90,000	86,000
eijing Mega Fab (12")	62,550	52,425
anjin Fab (8")	33,200	33,300
otal monthly wafer fabrication capacity	185,750	171,725

## Note:

 $<sup>\</sup>bullet$  Wafers per month at the end of the period in  $8\,^{\prime\prime}$  equivalent wafers

## **Shipment and Utilization**

8" equivalent wafers	1Q11	4Q10	1Q10
'afer shipments including copper interconnects	471,231	517,404	455,010
tilization rate <sup>(1)</sup>	72.2%	96.8%	92.1%

#### Note:

(1) Capacity utilization based on total wafer out divided by estimated capacity

• Wafer shipments decreased 8.9% QoQ to 471,231 units of 8-inch equivalent wafers in 1Q11 from 517,404 units of 8-inch equivalent wafers in 4Q10, and up 3.6% YoY from 455,010 8-inch equivalent wafers in 1Q10.

## **Detailed Financial Analysis**

## Gross Profit Analysis

Amounts in US\$ thousands	1Q11	4Q10	QoQ	1Q10	YoY
ost of sales	301,782	309,325	-2.4%	291,322	3.6%
epreciation	104,449	104,579	-0.1%	142,164	-26.5%
ther manufacturing costs	196,727	204,077	-3.6%	147,926	33.0%
nare-based compensation	606	669	-9.4%	1,232	-50.8%
ross profit	68,777	99,275	-30.7%	54,317	26.6%
ross margin	18.6%	24.3%		15.7%	

- Cost of sales decreased to \$301.8million in 1Q11, down 2.4% QoQ from \$309.3million in 4Q10 primarily due to a decrease in wafer shipments.
- Gross profit of \$68.8million in 1Q11, compared to a gross profit of \$99.3million in 4Q10 and gross profit of \$54.3million in 1Q10.
- Gross margin was 18.6% in 1Q11 from 24.3% in 4Q10 primarily due to a decline in fab utilization.

## Operating Expense Analysis

Amounts in US\$ thousands	1Q11	4Q10	QoQ	1Q10	YoY
otal operating expenses	76,623	53,880	42.2%	78,715	-2.7%
esearch and development	49,573	47,048	5.4%	43,480	14.0%
eneral and administrative	19,427	(7,538)	_	16,992	14.3%
elling and marketing	7,738	8,582	-9.8%	5,944	30.2%
thers, net	(115)	5,788		12,299	_

- R&D expenses increased to \$49.6million in 1Q11, up 5.4% QoQ from \$47.0million in 4Q10 due to increase in personnel related expenses.
- G&A expenses were \$19.4million in 1Q11, compared to a gain of \$(7.5) million in 4Q10 due to a \$28.5million recovery from bad-debt write-off in 4Q10.
- Selling & marketing expenses decreased to \$7.7million in 1Q11, down 9.8% QoQ from \$8.6 million in 4Q10 primarily due to a decrease in selling activities.
- Others, net were \$0.1million in 1Q11, compared to a loss of \$5.8million in 4Q10 due to reclassification of certain expenses.

# **Depreciation and Amortization**

• Depreciation and amortization in 1Q11 was \$130.9million compared to \$130.0million in 4Q10.

# Liquidity

Amounts in US\$ thousands	1Q11	4Q10
ash and cash equivalents	394,062	515,808
estricted cash	128,135	161,350
ccounts receivable	231,015	206,623
ventories	190,414	213,404
thers	141,220	81,917
otal current assets	1,084,846	1,179,102
ccounts payable	434,558	515,577
nort-term borrowings	628,182	372,055
urrent portion of long-term debt	281,608	333,459
thers	175,004	178,254
otal current liabilities	1,519,352	1,399,345
ash Ratio	0.3x	0.4x
uick Ratio	0.4x	0.5x
urrent Ratio	0.7x	0.8x

# Capital Structure\_

mounts in US\$ thousands	1Q11	4Q10
ash and cash equivalents	394,062	515,808
estricted cash	128,135	161,350
urrent portion of promissory notes	29,582	29,374
on-current portion of promissory notes	56,728	56,327
10rt-term borrowings	628,182	372,055
urrent portion of long-term debt	281,608	333,459
ong-term debt	179,132	178,596
otal debt	1,088,922	884,110
quity <sup>(1)</sup>	2,183,850	2,170,608
otal debt to equity ratio	49.9%	40.7%

(1) Including portion of noncontrolling interest.

#### **Cash Flow**

Amounts in US\$ thousands	1Q11	4Q10
et cash from operating activities	73,439	248,632
et cash from investing activities	(400,942)	(246,458)
et cash from financing activities	205,422	41,119
ffect of exchange rate changes	336	268
et change in cash	(121,746)	43,561

#### **Capex Summary**

• Capital expenditures for 1Q11 were \$332.8million.

#### **Recent Highlights and Announcements**

Spansion and SMIC Expand Foundry Agreement (2011-05-16)

Further Information on Major Transaction Establishment of a Joint Venture with Hubei Science & Technology Investment Group Co., Ltd (2011-05-12)

Announcement Major Transaction Establishment of a Joint Venture with Hubei Science & Technology Investment Group Co., Ltd (2011-05-12)

SMIC and Hubei Science & Technology Investment Group Sign Joint Venture Agreement in Wuhan (2011-05-12)

Notice of Extraordinary General Meeting (2011-05-10)

(1) Subscription of Convertible Preferred Shares and Warrants by Country Hill Limited, A

Wholly-owned Subsidiary of China Investment Corporation (2)Pre-emptive Subscription of Convertible

Preferred Shares and Warrants by Datang Holdings (hongkong)Investment Company Limited

(3) Proposed Special Mandate and Further Special Mandate to Issue Convertible Preferred Shares,

Warrants and Ordinary Shares on Conversion of the Convertible Preferred Shares (4) Notice of

Extraordinary General Meeting (2011-05-10)

Notification Letter and Request Form to Non-registered Holders (2011-05-10)

Notification Letter (2011-05-10)

Form of Proxy for Use at the Extraordinary General Meeting to be Held on 27 May, 2011 (2011-05-10)

Closure of Register of Members (2011-05-09)

Connected Transaction Pre-emptive Subscription of Convertible Preferred Shares and Warrants by

Datang Holdings (Hong Kong) Investment Company Limited (2011-05-06)

SMIC's Major Shareholder, Datang, Wishes to Subscribe for Pre-emptive Securities (2011-05-06)

Notification of Board Meeting (2011-04-29)

Letter and Reply Form to New Registered Shareholder — Election of Means of Receipt of Corporate Communication (2011-04-28)

Notification Letter and Request Form to Non-registered Holders (2011-04-28)

Notification Letter and Change Request Form to Registered Holders (2011-04-28)

Clarification Announcement (2011-04-21)

SMIC to Receive Investment from CIC (2011-04-19)

(1)Proposed Issue of Convertible Preferred Shares, Warrants and Warrant Preferred Shares to Country

Hill Limited, a Wholly-Owned Subsidiary of China Investment Corporation under Special Mandate

(2)Pre-emptive Right of Datang and (3)Pre-emptive Right of TSMC (2011-04-18)

SMIC Earns Texas Instruments' Supplier Excellence Award for 2010 (2011-04-07)

Announcement of 2010 Annual Results (2011-03-30)

SMIC CEO David Wang Joins GSA Board (2011-03-30)

Notification of Approval of the Publication of 2010 Annual Results by the Board (2011-03-17)

Clarification Announcement (2011-03-16)

RDA and SMIC Reach 55nm Joint Production Milestone — SMIC, RDA and Innopower collaborate on

China's leading 55nm FM Receiver chip now in production (2011-03-09)

SMIC Reports Results for the Three Months Ended December 31, 2010 (2011-02-17)

Fingerprint Cards and SMIC Work in Collaboration to Bring the World's Smallest and Most

Power-Efficient Fingerprint Sensor to China (2011-02-16)

Resignation of Alternate Director (2011-02-14)

Notification of Board Meeting (2011-01-18)

Please visit SMIC's website at http://www.smics.com/website/enVersion/Press\_Center/newsRelease.ftl for further details regarding the recent announcements.

## For the three months ended

	For the three months ended		
	March 31,2011	December 31,2010	
	(Unaudited)	(Unaudited)	
iles	370,559	408,600	
ost of sales	301,782	309,325	
coss profit	68,777	99,275	
perating expenses (income):			
esearch and development	49,573	47,048	
eneral and administrative	19,427	(7,538)	
illing and marketing	7,738	8,582	
:hers, net	(115)	5,788	
otal operating expenses, net	76,623	53,880	
come (loss)from operations	(7,846)	45,395	
otal other income, net	2,702	27,042	
come (loss)from continuing operations before income tax and equity			
investment	(5,144)	72,436	
come tax expense (benefit)	128	(388)	
come from equity investment	1,016	304	
come (loss)from continuing operations	(4,000)	72,352	
come (loss)from discontinued operations net of tax effect	14,742	(3,657)	
et income	10,742	68,695	
ccretion of interest to noncontrolling interest	(508)	(125)	
come attributable to Semiconductor Manufacturing International Corporation	10,234	68,570	
urnings (loss)per share from continuing operations, basic and diluted	(0.00)	0.00	
rnings (loss)per share from discontinued operations, basic and diluted	0.00	_	
rnings per share attributable to Semiconductor Manufacturing International			
Corporation ordinary shareholders, basic and diluted	0.00	0.00	
rnings (loss)per ADS from continuing operations, basic and diluted	(0.01)	0.13	
rnings (loss)per ADS from discontinued operations, basic and diluted	0.03	_	
urnings per ADS attributable to Semiconductor Manufacturing International	0.02	0.13	

Corporation ordinary shareholders, basic and diluted		
nares used in calculating basic earnings per share	27,370,653,849	26,547,114,260
nares used in calculating diluted earnings per share	27,370,653,849	26,748,653,881

	As of	
Ma	arch 31,2011	December 31,2010
	Unaudited)	(Unaudited)
SSETS		
arrent assets:		
ash and cash equivalents	394,062	515,808
estricted cash	128,135	161,350
ecounts receivable, net of allowances of \$50,200,060 and \$49,373,296		
at March31, 2011 and December31, 2010 respectively	231,015	206,623
ventories	190,414	213,404
epaid expense and other current assets	141,220	81,917
otal current assets	1,084,846	1,179,102
epaid land use rights	78,387	78,798
ant and equipment, net	2,518,710	2,351,863
equired intangible assets, net	184,786	173,821
ther long-term assets	136,914	119,109
OTAL ASSETS	4,003,643	3,902,693
=		
ABILITIES AND EQUITY		
ırrent liabilities:		
counts payable	434,558	515,577
crued expenses and other current liabilities	145,422	148,879
ort-term borrowings	628,182	372,055
arrent portion of promissory notes	29,582	29,374
arrent portion of long-term debt	281,608	333,459
otal current liabilities	1,519,352	1,399,345
-		
ong-term liabilities:		
omissory notes	56,728	56,327
ong-term debt	179,131	178,596

ther long-term liabilities	62,238	59,883
otal long-term liabilities	298,097	294,806
otal liabilities	1,817,449	1,694,151
oncontrolling interest	3,451	39,004
rdinary shares, \$0.0004 par value, 50,000,000,000 shares authorized,		
27,396,956,059 and 27,334,063,747 shares issued and outstanding at		
March31, 2011 and December31, 2010, respectively	10,959	10,934
iditional paid-in capital	3,861,254	3,858,643
ocumulated other comprehensive loss	(757)	(1,092)
cumulated deficit	(1,688,713)	(1,698,947)
otal equity	2,182,743	2,169,538
OTAL LIABILITIES, NONCONTROLLING INTEREST AND		
EQUITY	4,003,643	3,902,693
	4,003,643	3,902,693

For the three months ended

	March 31,2011 (Unaudited)	December 31,2010 (Unaudited)
ash Flows from Operating activities		
et income	10,742	68,695
epreciation and amortization	130,929	129,976
ain from equity investment	(1,016)	(305)
ain on deconsolidation of a subsidiary	(20,617)	_
nanges in working capital and others:	(46,600)	50,265
et cash provided by operating activities	73,439	248,632
ash Flows from Investing activities: equisitions of:		
operty, plant and equipment	(392,576)	(173,341)
tangible assets	(7,023)	9,729
ort-term investments	(22,433)	(2,144)
nanges in restricted cash relating to investing activities	17,180	(87,294)
:hers	3,910	6,592
et cash used in investing activities	(400,942)	(246,458)

	<del></del>	
ash Flows from Financing activities:		
crease (decrease)in short-term loans	256,127	(30,193)
crease (decrease)long-term loans	(51,315)	(11,076)
epayment of promissory notes	_	(20,000)
oceeds from issuance of ordinary shares	_	102,000
:hers	610	388
et cash provided by (used in) financing activities	205,422	41,119
fect of exchange rate changes	335	268
ET INCREASE (DECREASE)IN CASH AND CASH		
QUIVALENTS	(121,746)	43,561
ASH AND CASH EQUIVALENTS, beginning of period	515,808	472,247
ASH AND CASH EQUIVALENTS, end of period	394,062	515,808

As at the date of this announcement, the directors of the Company are Jiang Shang Zhou as Chairman of the Board of Directors and Independent Non-Executive Director of the Company; Dr. David N. K. Wang as President, Chief Executive Officer and Executive Director; Chen Shanzhi, Gao Yonggang and Zhou Jie as Non-Executive Directors of the Company; and Tsuyoshi Kawanishi and Lip-Bu Tan as the other Independent Non-Executive Directors of the Company.

By order of the Board

### **Semiconductor Manufacturing International Corporation**

Dr. David N. K. Wang

President, Chief Executive Officer

**Executive Director** 

Shanghai, PRC

May 19, 2011